

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	1121	257/786.ccls.	USPAT; US-PGPUB
2	BRS	L2	1458	257/773.ccls.	USPAT; US-PGPUB
3	BRS	L3	454	257/775.ccls.	USPAT; US-PGPUB
4	BRS	L4	505	L1 and (slit or aperture or hole)	USPAT; US-PGPUB
5	BRS	L5	728	L2 and (slit or aperture or hole)	USPAT; US-PGPUB
6	BRS	L6	259	L3 and (slit or aperture or hole)	USPAT; US-PGPUB
7	BRS	L10	454	257/775.ccls.	USPAT; US-PGPUB
8	BRS	L11	259	L10 and (slit or aperture or hole)	USPAT; US-PGPUB
9	BRS	L9	35	L6 and recess	USPAT; US-PGPUB
10	BRS	L12	35	L11 and recess	USPAT; US-PGPUB
11	BRS	L7	67	L4 and recess	USPAT; US-PGPUB
12	BRS	L8	91	L5 and recess	USPAT; US-PGPUB
13	BRS	L13	1972	Chip adj scale adj package	USPAT; US-PGPUB
14	BRS	L14	1085	L13 and (slit or aperture or hole)	USPAT; US-PGPUB
15	BRS	L15	210	L14 and recess	USPAT; US-PGPUB
16	BRS	L16	194	L15 and (pad or electrode)	USPAT; US-PGPUB
17	BRS	L17	2055	(wiring adj layer) and stress and (slit or aperture or hole)	USPAT; US-PGPUB
18	BRS	L18	305	L17 and (pad or electrode) and recess	USPAT; US-PGPUB
19	BRS	L19	189	L17 and (pad or electrode) and dummy	USPAT; US-PGPUB
20	BRS	L20	1	"6399897".PN.	USPAT
21	BRS	L21	1	"5885857".PN.	USPAT
22	BRS	L22	1	"5763936".PN.	USPAT
23	BRS	L23	1272	257/737.ccls.	USPAT; US-PGPUB
24	BRS	L24	61	L23 and (pad or electrode) and dummy	USPAT; US-PGPUB
25	BRS	L25	355	257/786.ccls.	EPO; JPO; IBM TDB
26	BRS	L26	449	257/773.ccls.	EPO; JPO; IBM TDB
27	BRS	L27	121	257/775.ccls.	EPO; JPO; IBM TDB
28	BRS	L28	235	257/737.ccls.	EPO; JPO; IBM TDB